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# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







Transistors with Built-in Resistor

### DRC5114Y0L

### DRC5114Y0L

**Panasonic** 

#### Silicon NPN epitaxial planar type

For digital circuits
Complementary to DRA5114Y
DRC2114Y in SMini3 type package

#### ■ Features

- Low collector-emitter saturation voltage Vce(sat)
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

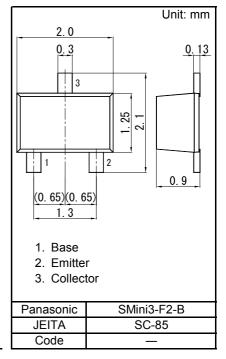
■ Marking Symbol: NC

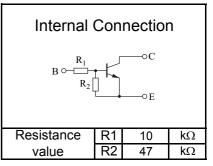
#### ■ Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	VCBO	50	V
Collector-emitter voltage (Base open)	VCEO	50	V
Collector current	IC	100	mA
Total power dissipation	PT	150	mW
Junction temperature	Tj	150	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +150	°C





#### ■ Electrical Characteristics Ta = 25 °C ± 3 °C

Established: 2009-10-15

: 2014-03-20

Revised

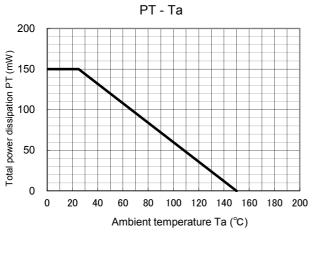
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	VCBO	IC = 10 μA, IE = 0	50			V
Collector-emitter voltage (Base open)	VCEO	IC = 2 mA, IB = 0	50			V
Collector-base cutoff current (Emitter open)	ICBO	VCB = 50 V, IE = 0			0.1	μΑ
Collector-emitter cutoff current (Base open)	ICEO	VCE = 50 V, IB = 0			0.5	μΑ
Emitter-base cutoff current (Collector open)	IEBO	VEB = 6 V, IC = 0			0.2	mA
Forward current transfer ratio	hFE	VCE = 10 V, IC = 5 mA	80			ı
Collector-emitter saturation voltage	VCE(sat)	IC = 10 mA, IB = 0.5 mA			0.25	V
Input voltage	Vi(on)	VCE = 0.2 V, IC = 5 mA	1.7			V
	Vi(off)	VCE = 5 V, IC = 100 μA			0.5	V
Input resistance	R1		-30%	10	+30%	kΩ
Resistance ratio	R1/R2		0.17	0.21	0.25	-

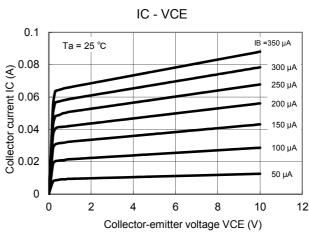
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

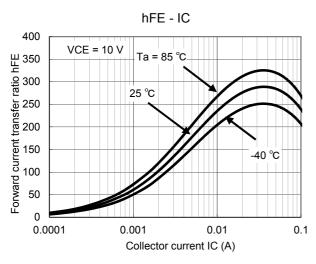
## DRC5114Y0L

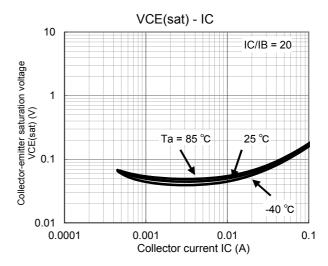
# **Panasonic**

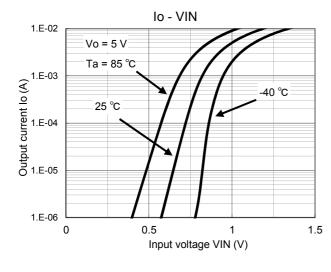
## Technical Data (reference)

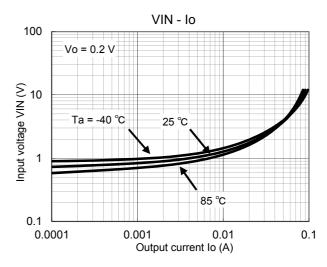












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Established: 2009-10-15 Revised: 2014-03-20

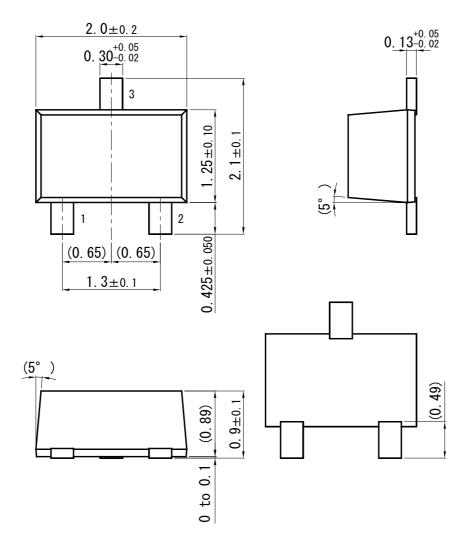
Transistors with Built-in Resistor

## DRC5114Y0L

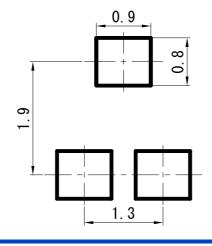
# SMini3-F2-B

**Panasonic** 

Unit: mm



#### ■ Land Pattern (Reference) (Unit: mm)



Established: 2009-10-15 Revised: 2014-03-20

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